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JUN 02 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Tan et al.
Serial No.: 09/736,462
Filing Date: December 15, 2000
Group Art Unit: 2831
Examiner: Ngo, Hung V
Title: BUMP CHIP LEAD FRAME AND PACKAGE

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING FACSIMILE
TRANSMITTED TO THE PATENT AND TRADEMARK OFFICE, ATTN EXAMINER
Ngo, Hung V, AT THE FAX NO. (703) 872-9306

ON:

Date of Facsimile Transmission

Lydia McNamara

Name of Person Signing Certificate

SIGNATURE

DATE

Commissioner for Patents,
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER ALLOWANCE

SIR:

As discussed by phone on June 1, 2004 by Patent Engineer
Bruce Huling and Primary Examiner Ngo, please amend the above-
identified application drawings as follows.